



ZigBee-Ready RF Transceiver Module
(IEEE 802.15.4)
CTLA357/CTLB357

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ZigBee- Ready RF Transceiver Module CTLA357/CTLB357

Revision

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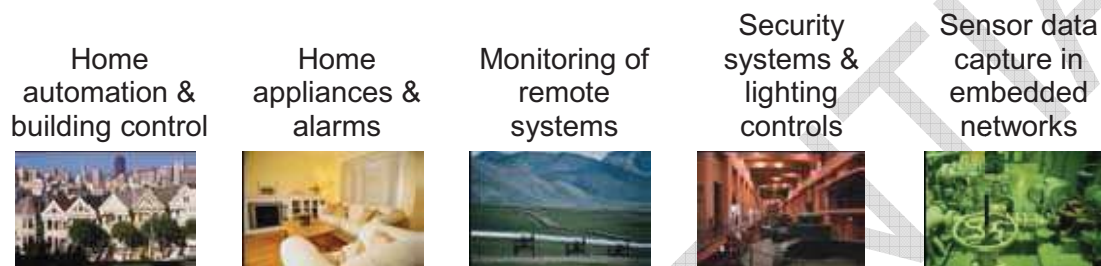
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1. General Description

The CTLA357 and CTLB357 are compact surface mounted High Power Wireless RF Transceiver Module specially designed for Ember ZigBee™ protocol stack for wireless networks, EmberZNet, based on IEEE 802.15.4 standard in the 2.4GHz world-wide ISM band. The size of CTLA357/CTLB357 is 32.4 x 25.4 x 4.1 mm. It integrated a 2.4GHz, IEEE 802.15.4-2003 compliant transceiver with a 32-bit network processor (ARM Cortex-M3 Processor) to run EmberZNet. It contains embedded FLASH and integrated RAM for program and data storage. It utilizes the non-intrusive SIF module for powerful software debugging and programming of the network processor.

2. Applications



3. Features

- Complete ZigBee-ready module with integrated PCB antenna
- Integrated IEEE 802.15.4 PHY and MAC layer
- Non-intrusive debug interface (SIF)
- SPI interface for communication and controlled by the Host using the EmberZNet Serial Protocol (EZSP)
- Internal RC oscillator for timer
- High performance direct sequence spread spectrum (DSSS) RF transceiver
- 16 channels in the 2.4 GHz ISM band
- On-chip regulator for 2.1-3.6V operation.
- Three deep low power modes
- 32-bit ARM® Cortex™-M3 processor
- 192KB FLASH ROM and 12KB RAM(EM357 internal)
- 8Mb off chip FLASH memory (CTLB357)
- +18dBm+/-1dBm Max. transmission power
- -100dBm sensitivity
- Small footprint: 32.4 x 25.4 x 4.1 mm
- Extremely low Deep Sleep Current.

4. Absolute Maximum Ratings

Parameter	Test Conditions	Min.	Max.	Unit
Regulator input voltage (VDD_PADS)		-0.3	+3.6	V
Voltage on any GPIO (PA[7:0], PB[7:0], PC[7:0]), SWCLK, nRESET, VREG_OUT		-0.3	VDD_PADS +0.3	V
Voltage on any GPIO pin (PA4, PA5, PB5, PB6, PB7, PC1), when used as an input to the general purpose ADC with the low voltage range selected		-0.3	2.0	V
Voltage on OSCA, OSCB, NC		-0.3	VDD_PADS +0.3	V
Storage temperature		-40	+85	°C

5. Recommended Operating Conditions

Parameter	Test Conditions	Min.	Typ.	Max.	Unit
Regulator input voltage (VDD_PADS)		2.1		3.6	V
Operating temperature range		-40		+85	°C
Moisture Sensitivity Level(MSL)		MSL3			

6. Electrical Specifications

T=25°C, VCC = 3.0V, Fo =2450MHz, if nothing else stated.

Parameter	Condition / Note	Min	Typ.	Max	Unit
RF Operating frequency	Programmable in 5MHz steps, 5 MHz steps for IEEE 802.15.4 compliance	2.405		2.480	GHz
Number of channels	For IEEE 802.15.4 compliance		16		
Channel spacing	For IEEE 802.15.4 compliance		5		MHz
Frequency stability				+/-40	ppm
Transmit power	Programmable from firmware			+18+/-1	dBm
Sensitivity	PER = 1% PER, 20byte packet defined by IEEE 802.15.4 Boost mode		-100		dBm
Adjacent channel rejection +/-5 MHz	IEEE 802.15.4 compliance at -82 dBm		35/35		dB
Adjacent channel rejection +/-10 MHz	IEEE 802.15.4 compliance at -82 dBm		40/40		dB

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Parameter		Condition / Note	Min	Typ.	Max	Unit
Supply voltage			2.1		3.6	V
Current consumption, RX mode		Max RX sensitivity (normal mode)		28		mA
		Max RX sensitivity (boost mode)		30		mA
Current consumption, TX mode	CTLA357, CTLB357			150		mA
Deep sleep current	CTLA357			2.8		uA
	CTLB357			8	12	uA
Flash Memory	CTLA357, CTLB357	FLASH memory in EM357		192		KB
	CTLB357	Off chip Serial FLASH		8		Mb
RAM		Internal RAM in EM357		12		KB
MCU clock frequency				24		MHz
MCU Low Speed Clock				32.768		KHz

7. Typical application block

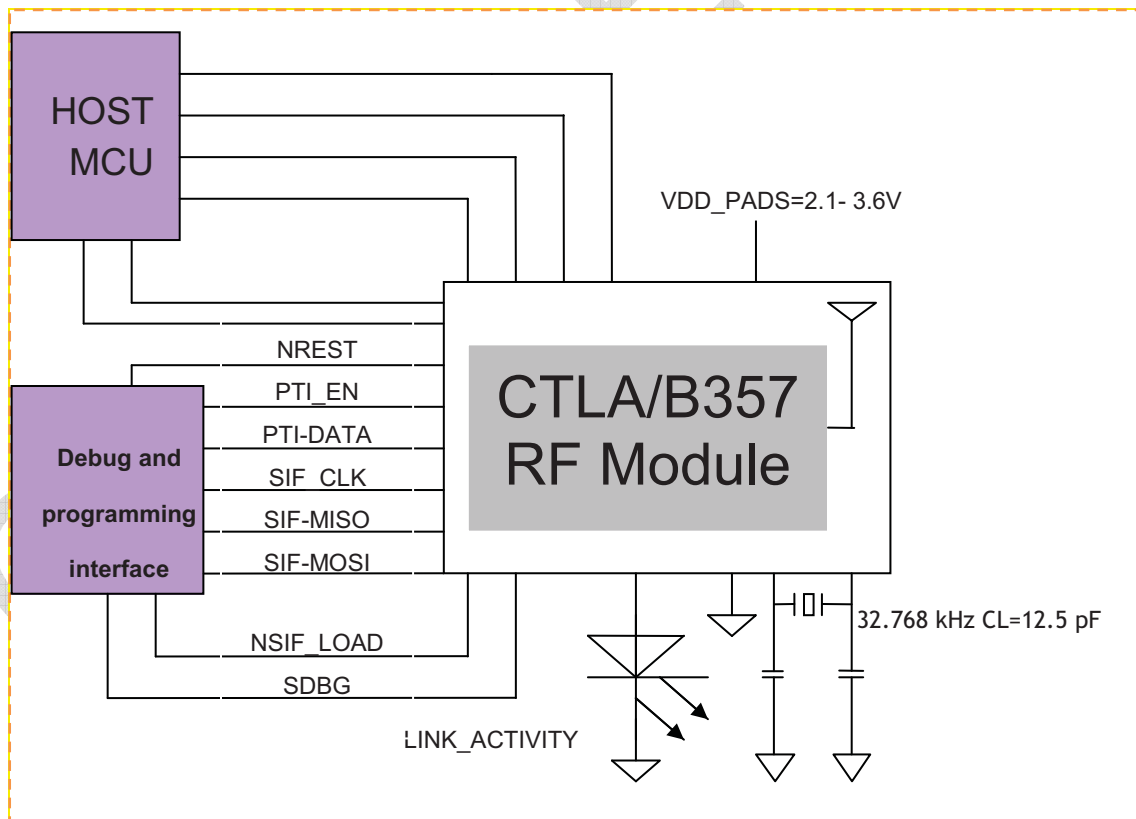


Figure 1: Example of application circuit

8. Pin Assignment

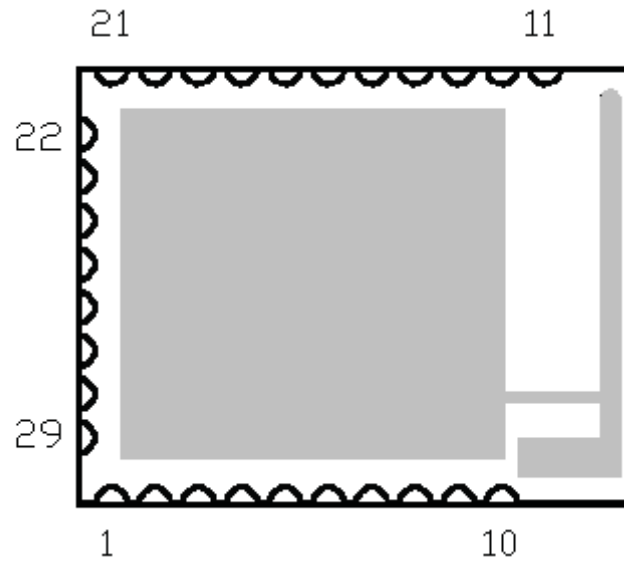


Figure 2: CTLA357/CTLB357 pin assignment

9. Pin Description

Pin#	CTLA357	CTLB357	Direction	Description
1	JTCK	JTCK	I	JTAG clock input from debugger
	SWCLK	SWCLK	I/O	Serial Wire Clock input/output with debugger
2	PC2	PC2	I/O	Digital I/O Enable with GPIO_DBGCFG[5]
	JTDO	JTDO	O	JTAG data out to debugger
	SWO	SWO	O	Serial Wire Output asynchronous trace output to debugger
3	PC3	PC3	I/O	Digital I/O Enable with GPIO_DBGCFG[5]
	JTDI	JTDI	I	JTAG data in from debugger
4	PC4	PC4	I/O	Digital I/O Either Enable with GPIO_DBGCFG[5]
	JTMS	JTMS	I	JTAG mode select from debugger
	SWDIO	SWDIO	I/O	Serial Wire bidirectional data to/from debugger
5	PC0	PC0	I/O High current	Digital I/O Either Enable with GPIO_DBGCFG[5]
	JRST	JRST	I	JTAG reset input from debugger
	IRQD	IRQD	I	Default external interrupt source D
	TRACEDATA1	TRACEDATA1	O	Synchronous CPU trace data bit 1
6	PB7	PB7	I/O High current	Digital I/O
	ADC2	ADC2	Analog	ADC input 2
	IRQC	IRQC	I	Default external interrupt source C
	TIM1C2	TIM1C2	O	Timer 1 channel 2 output
	TIM1C2	TIM1C2	I	Timer 1 channel 2 input
7	PB6	PB6	I/O High current	Digital I/O
	ADC1	ADC1	Analog	ADC input 1
	IRQB	IRQB	I	External interrupt source B
	TIM1C1	TIM1C1	O	Timer 1 channel 1 output
	TIM1C1	TIM1C1	I	Timer 1 channel 1 input

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Pin#	CTLA357	CTLB357	Direction	Description
8	PA7	PA7	I/O High current	Digital I/O Disable REG_EN with GPIO_DBGCFG [4]
	TIM1C4	TIM1C4	O	Timer 1 channel 4 output
	TIM1C4	TIM1C4	I	Timer 1 channel 4 input
	REG_EN	REG_EN	O	External regulator open drain output
9	PC1	PC1	O	RX Enable: High RX Disable: Low
10	GND	GND		
11	PB3	PB3	I/O	Digital I/O
	TIM2C3	TIM2C3	O	Timer 2 channel 3 output
	TIM2C3	TIM2C3	I	Timer 2 channel 3 input
	SC1nCTS	SC1nCTS	I	UART CTS handshake of Serial Controller 1
	SC1SCLK	SC1SCLK	O	SPI master clock of serial Controller 1
	SC1SCLK	SC1SCLK	I	SPI slave clock of serial Controller 1
12	GND	GND		
13	PC6	PC6	I/O	Digital I/O
			I/O	32.768KHz crystal oscillator. If this pin is used for oscillation, then cannot be use for other purposes, such as general I/O port.
	NTX_ACTIVE	NTX_ACTIVE	O	Inverted TX_ACTIVE signal
14	PC7	PC7	I/O	Digital I/O
			I/O	32.768KHz crystal oscillator. If this pin is used for oscillation, then cannot be use for other purposes, such as general I/O port.
	OSC32_EXT	OSC32_EXT	I	Digital 32.768KHz clock input source
15	GND	GND		
16	VDD_PADS	VDD_PADS	Power	Pads supply(2.1-3.6V)
17	nRESET	nRESET	I	Active low chip reset(internal pull-up)

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Pin#	CTLA357	CTLB357	Direction	Description
18	PA0	PA0	I/O	Digital I/O
	TIM2C1	TIM2C1	O	Timer 2 channel 1 output
	TIM2C1	TIM2C1	I	Timer 2 channel 1 input
	SC2MOSI	SC2MOSI	O	SPI master data out of serial controller 2
	SC2MOSI	SC2MOSI	I	SPI slave data in of serial controller 2
		SI	I	Serial data in for off-chip 8Mb flash. It connected to AT25DF081A. So it cannot be used for other purposes.
19	PA1	PA1	I/O	Digital I/O
	TIM2C3	TIM2C3	O	Timer 2 channel 3 output
	TIM2C3	TIM2C3	I	Timer 2 channel 3 input
	SC2SDA	SC2SDA	I/O	I2C data of serial controller 2
	SC2MISO	SC2MISO	O	SPI slave data out of serial controller 2
	SC2MISO	SC2MISO	I	SPI master data in of serial controller 2
	SO	O	Serial data out for off-chip 8Mb flash. It connected to AT25DF081A. So it cannot be used for other purposes.	
20	PA2	PA2	I/O	Digital I/O
	TIM2C4	TIM2C4	O	Timer 2 channel 4 output
	TIM2C4	TIM2C4	I	Timer 2 channel 4 input
	SC2SCL	SC2SCL	I/O	I2C clock of serial controller 2
	SC2SCLK	SC2SCLK	O	SPI master clock of serial controller 2
	SC2SCLK	SC2SCLK	I	SPI slave clock of serial controller 2
	SCK	I	Clock in for 8Mb flash. It connected to AT25DF081A. So it cannot be used for other purposes.	
21	PA6	PA6	I/O High current	Digital I/O
	TIM1C3	TIM1C3	O	Timer 1 channel 3 output
	TIM1C3	TIM1C3	I	Timer 1 channel 3 input

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Pin#	CTLA357	CTLB357	Direction	Description
22	PB4	PB4	I/O	Digital I/O
	TIM2C4	TIM2C4	O	Timer 2 channel 4 output
	TIM2C4	TIM2C4	i	Timer 2 channel 4 input
	SC1nRTS	SC1nRTS	O	UART RTS handshake of serial controller 1
	SC1nSSEL	SC1nSSEL	I	SPI slave select of serial controller 1
23	PA3	PA3	I/O	Digital I/O
	SC2Nssel	SC2Nssel	I	SPI slave select of serial controller 2
	TRACECLK	TRACECLK	O	Synchronous CPU trace clock
	TIM2C2	TIM2C2	O	Timer 2 channel 2 output
	TIM2C2	TIM2C2	I	Timer 2 channel 2 input
		CE#	I	Chip Enable of 8Mb falsh. It connected to AT25DF081A. So it cannot be used for other purposes, such as general I/O port.
24	PA4	PA4	I/O	Digital I/O
	ADC4	ADC4	Analog	ADC input 4
	PTI_EN	PTI_EN	O	Frame signal of packet trace interface
	TRACEDATA2	TRACEDATA2	O	Synchronous CPU trace data bit 2
25	PA5	PA5	I/O	Digital I/O
	ADC5	ADC5	Analog	ADC input 5
	PTI_DATA	PTI_DATA	O	Data signal of packet trace interface
	NBOOTMODE	NBOOTMODE	I	Embedded serial bootloader activation out of reset
	TRACEDATA3	TRACEDATA3	O	Synchronous CPU trace data bit 3
26	PB1	PB1	I/O	Digital I/O
	SC1MISO	SC1MISO	O	SPI slave data out of serial controller 1
	SC1MOSI	SC1MOSI	O	SPI master data out of serial controller 1
	SC1SDA	SC1SDA	I/O	TWI data of serial controller 1
	SC1TXD	SC1TXD	O	UART transmit data of serial controller 1
	TIM2C1	TIM2C1	O	Timer 2 channel 1 output
	TIM2C1	TIM2C1	I	Timer 2 channel 1 input

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Pin#	CTLA357	CTLB357	Direction	Description
27	PB2	PB2	I/O	Digital I/O
	SC1MISO	SC1MISO	I	SPI master data in of serial controller 1
	SC1MOSI	SC1MOSI	I	SPI slave data in of serial controller 1
	SC1SCL	SC1SCL	I/O	TWI clock of serial controller 1
	SC1RXD	SC1RXD	I	UART receive data of serial controller 1
	TIM2C2	TIM2C2	O	Timer 2 channel 2 output
	TIM2C2	TIM2C2	I	Timer 2 channel 2 input
28	PB5	PB5	I/O	Digital I/O
	ADC0	ADC0	Analog	ADC input 0
	TIM2CLK	TIM2CLK	I	Timer 2 external clock input
	TIM1CLK	TIM1CLK	I	Timer 1 external clock mask input
29	PB0	PB0	I/O	Digital I/O
	VREF	VREF	Analog O	ADC reference output
	VREF	VREF	Analog I	ADC reference input
	IRQA	IRQA	I	External interrupt source A
	TRACECLK	TRACECLK	O	Synchronous CPU trace clock
	TIM1CLK	TIM1CLK	I	Timer 1 external clock input
	TIM2MSK	TIM2MSK	I	Timer 2 external clock mask input

10. Block Diagram

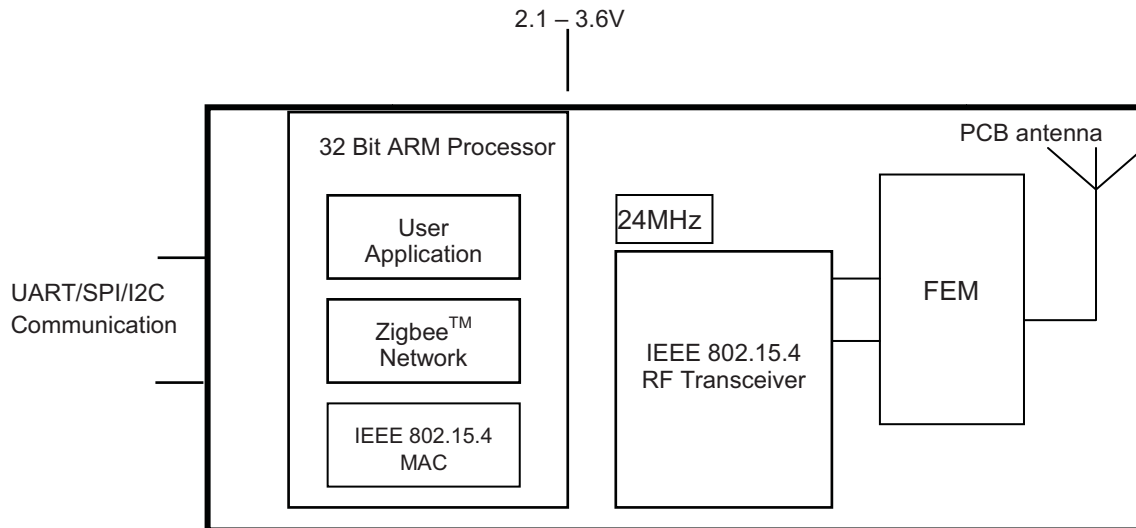


Figure 3: CTLA357 Block Diagram

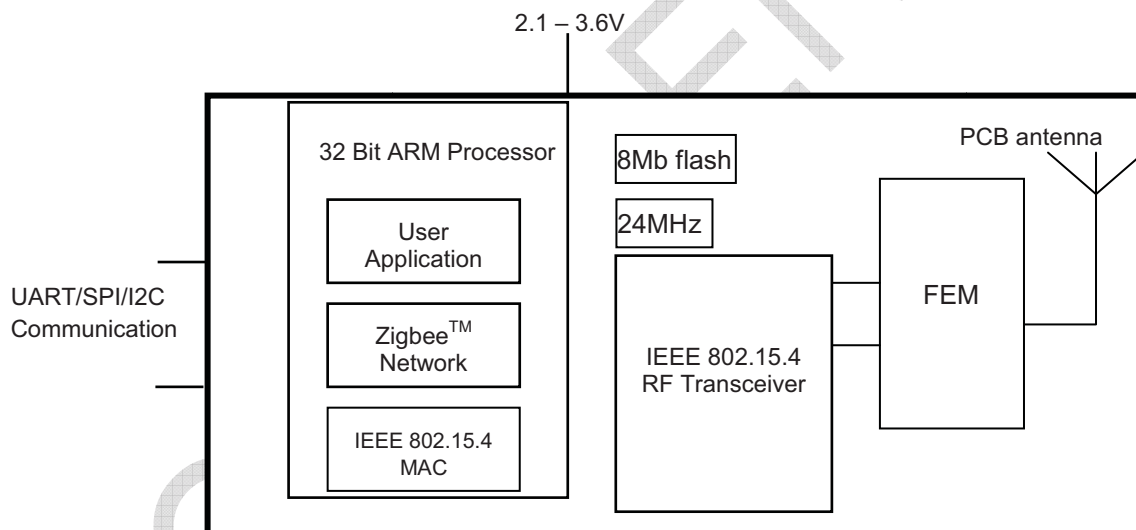


Figure 4: CTLB357 Block Diagram

11. RF Frequency Detail

The following table shows the RF channels as defined by the IEEE 802.15.4 standard.

RF channel	Frequency
11	2405MHz
12	2410MHz
13	2415MHz
14	2420MHz
15	2425MHz
16	2430MHz
17	2435MHz
18	2440MHz
19	2445MHz
20	2450MHz
21	2455MHz
22	2460MHz
23	2465MHz
24	2470MHz
25	2475MHz
26	2480MHz

Note: The output power of CTLA357/CTLB357 should be configured lower than -3.5dBm for 2480M channel to Comply FCC requirement.

The use of RF frequencies and maximum allowed RF power should according to different national regulations. The CTLA357/CTLB357 are complying with the applicable regulations for the world wide 2.4GHz ISM band.

The following table is the setting for the CTLA357/CTLB357 to US market:

FCC		
Channel	CH11~25	CH26
Freq(MHz)	2405~2475	2480
Ember setting	+18+/-1dBm	-3+/-1dBm

12. PCB Layout Recommendations

Please reference Mechanical Dimensions shown in next section for PCB layout.

The area underneath the module should be covered with solder mask in order to prevent short circuit on the test pads on the back side of the module. A solid ground plane under the module is preferred.

As the module integrated with onboard PCB trace antenna, the mounting position of the module will have great impact on the RF performance. There should not be any trace, ground plane or metal part underneath or nearby the area of the onboard PCB trace antenna. The figure below shows an example how the module positioned on the mother PCB.

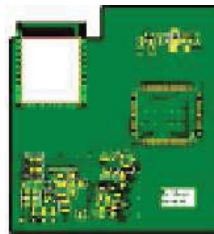


Figure 4: A recommended placement of the module on a main PCB

13. Mechanical Dimensions

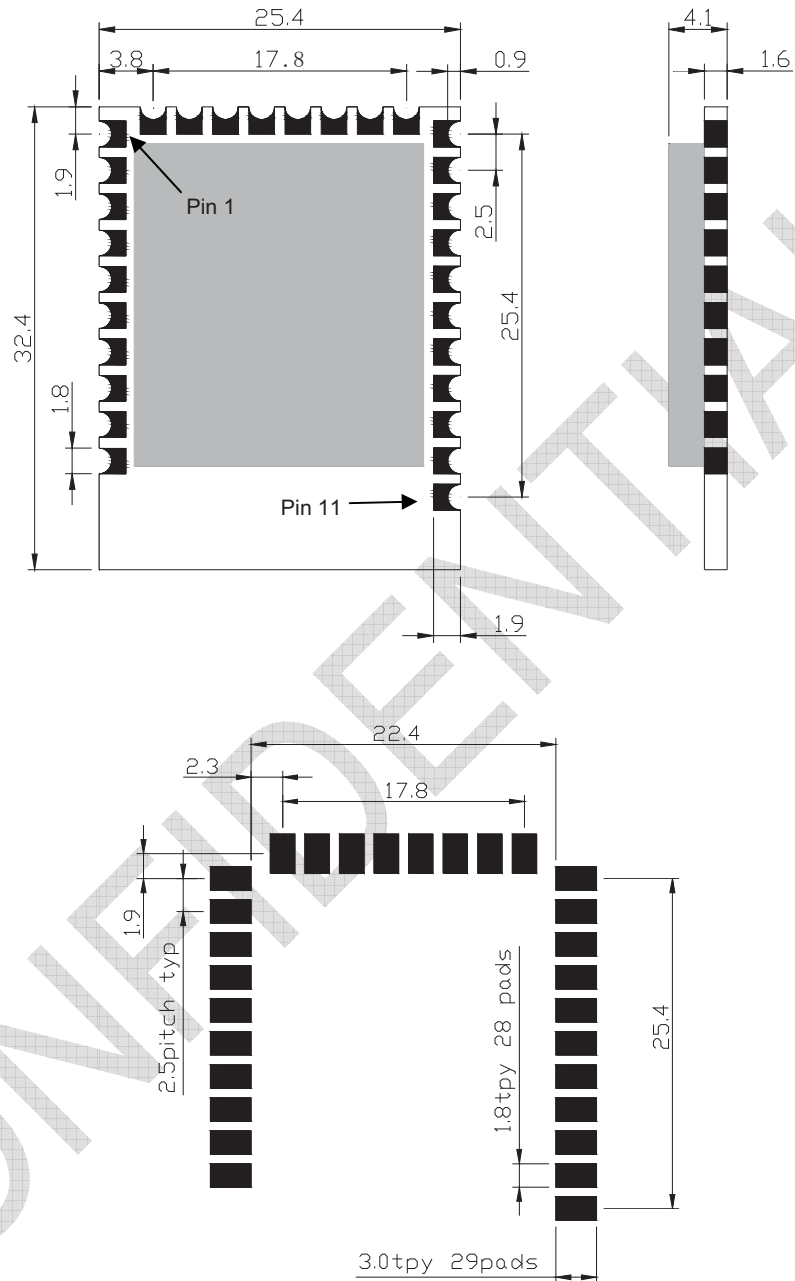


Figure 5: Mechanical Dimensions of CTLA357/CTLB357

For further details on the SoC transceiver (Ember EM357), please consult the data sheet at <http://www.silabs.com/products/wireless/zigbee/Pages/default.aspx>



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About Computime

Founded in 1974, **Computime** is a global technology, brand and manufacturing company providing innovative automation and control solutions to customers in commercial, industrial and consumer markets.

The Company provides technologies and products that save energy and make people's lives more productive and comfortable.

FCC Statement

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to Part 15 of the FCC Rules.

These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following

measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.

FCC Radiation Exposure Statement

The modular can be installed or integrated in mobile or fix devices only. This modular cannot be installed in any portable device, for example, USB dongle like transmitters is forbidden.

This modular complies with FCC RF radiation exposure limits set forth for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. This modular must be installed and operated with a minimum distance of 20 cm between the radiator and user body.

If the FCC identification number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following:

"Contains Transmitter Module FCC ID: 2AAUQ-CTLB357 Or Contains FCC ID: 2AAUQ-CTLB357 "

when the module is installed inside another device, the user manual of this device must contain below warning statements;

1. This device complies with Part 15 of the FCC Rules. Operation is subject to the following two conditions:

- (1) This device may not cause harmful interference.
- (2) This device must accept any interference received, including interference that may cause undesired operation.

2. Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

The devices must be installed and used in strict accordance with the manufacturer's instructions as described in the user documentation that comes with the product

IC STATEMENT

This device complies with Industry Canada's licence-exempt RSSs. Operation is subject to the following two conditions:

- (1) This device may not cause interference; and
- (2) This device must accept any interference, including interference that may cause undesired operation of the device.

Cet appareil est conforme aux CNR exemptes de licence d'Industrie Canada . Son fonctionnement est soumis aux deux conditions suivantes :

- (1) Ce dispositif ne peut causer d'interférences ; et
- (2) Ce dispositif doit accepter toute interférence , y compris les interférences qui peuvent causer un mauvais fonctionnement de l'appareil.

IC Radiation Exposure Statement

The modular can be installed or integrated in mobile or fix devices only. This modular cannot be installed in any portable device, for example, USB dongle like transmitters is forbidden.

This modular complies with IC RF radiation exposure limits set forth for an uncontrolled environment. This transmitter must not be co-located or operating in conjunction with any other antenna or transmitter. This modular must be installed and operated with a minimum distance of 20 cm between the radiator and user body. Cette modulaire doit être installé et utilisé à une distance minimum de 20 cm entre le radiateur et le corps de l'utilisateur.

If the IC number is not visible when the module is installed inside another device, then the outside of the device into which the module is installed must also display a label referring to the enclosed module. This exterior label can use wording such as the following:

“Contains IC:1700D-CTLB357”

when the module is installed inside another device, the user manual of this device must contain below warning statements;

1. This device complies with Industry Canada's licence-exempt RSSs. Operation is subject to the following two conditions:

- (1) This device may not cause interference; and
- (2) This device must accept any interference, including interference that may cause undesired operation of the device.

2. Cet appareil est conforme aux CNR exemptes de licence d'Industrie Canada . Son fonctionnement est soumis aux deux conditions suivantes :

- (1) Ce dispositif ne peut causer d'interférences ; et
- (2) Ce dispositif doit accepter toute interférence , y compris les interférences qui peuvent causer un mauvais fonctionnement de l'appareil.

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